PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT3113213

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	RELEASE OF SECURITY INTEREST

CONVEYING PARTY DATA

Name	Execution Date
CAPITAL IP INVESTMENT PARTNERS LLC	11/14/2014

RECEIVING PARTY DATA

Name:	SITIME CORPORATION
Street Address:	990 ALMANOR AVENUE
City:	SUNNYVALE
State/Country:	CALIFORNIA
Postal Code:	94085

PROPERTY NUMBERS Total: 30

Property Type	Number
Patent Number:	8749315
Patent Number:	8669664
Patent Number:	8667665
Patent Number:	8324729
Patent Number:	8299826
Patent Number:	8283987
Patent Number:	8234774
Patent Number:	8022554
Patent Number:	7808332
Patent Number:	7545239
Patent Number:	7545238
Patent Number:	7545237
Patent Number:	7545228
Patent Number:	7544531
Patent Number:	7446620
Patent Number:	7446619
Patent Number:	7443258
Patent Number:	7403147
Patent Number:	7369004
Patent Number:	7369003
Application Number:	14300114

Property Type	Number
Application Number:	14191978
Application Number:	14191939
Application Number:	61937601
Application Number:	13837407
Application Number:	13759013
Application Number:	13653640
Application Number:	13607603
Application Number:	13607597
Application Number:	11593404

CORRESPONDENCE DATA

Fax Number: (415)393-9887

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ATTORNEY DOCKET NUMBER:	045747.00113
NAME OF SUBMITTER:	DEREK R. LOWREY
SIGNATURE:	/Derek R. Lowrey/
DATE SIGNED:	11/18/2014

Total Attachments: 4
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TERMINATION AND RELEASE OF SECURITY INTEREST IN PATENTS

WHEREAS, SiTime Corporation, a Delaware corporation (the "Company") entered into that certain Credit Agreement, dated as of June 30, 2014 (as amended, supplemented and restated from time to time), that certain Pledge and Security Agreement, dated as of June 30, 2014 (as amended, supplemented and restated from time to time), and that certain Short-Form Patent Security Agreement, dated as of June 30, 2014 (as amended, supplemented and restated from time to time, the "Patent Security Agreement"), all by and between the Company and Capital IP Investment Partners LLC, as administrative and collateral agent (in such capacity, the "Secured Party"), pursuant to which the Company granted a security interest (the "Security Interest") in all of the Company's right, title and interest in and to the Company's patents including, without limitation, the patents set forth on the attached Schedule A (the "Specified Patents"), all to the extent set forth in the Patent Security Agreements; and

WHEREAS, the Secured Party desires to terminate, discharge and release the Security Interest, without representation or warranty whatsoever, in the Specified Patents (the "Release").

NOW THEREFORE, in consideration of the foregoing and intending to be legally bound, the Secured Party hereby releases the Security Interest in the Specified Patents, and hereby, (i) waives and relinquishes all its rights, powers, privileges and remedies under the Patent Security Agreement with respect to the Specified Patents, (ii) sells, assigns, conveys, transfers and sets over to the Company, without representation or warranty whatsoever, any right, title or interest that the Secured Party may have acquired and re-vests in the Company the full unencumbered title to the Specified Patents and the goodwill associated therewith, (iii) releases the Company from all covenants, obligations, liabilities and warranties under the Patent Security Agreement related to the Specified Patents and (iv) authorizes the Company and the Company's authorized representative, at the Company's sole cost and expense, to (x) record this Release with the USPTO and/or (y) otherwise record or file this Release in the applicable governmental office or agency.

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CAPITAL IP INVESTMENT PARTNERS LLC,
as Secured Party

By: _____
Name: _____
Title: _____
Date: _____

SCHEDULE A

PATENTS

SiTime Patents

Patent Number	Application Number	Filed Date	Priority Doc	Earliest Non-provisional Priority Date	Adjust-ment Days	Expiration Date	Title
8,749,315	13/561,862	30-Jul-12	60/970,233	24-Mar-08	0	19-Mar-28	Resonator Electrode Shields
8,669,664	13/681,065	19-Nov-12	60/813,874	15-Jun-07	0	10-Jun-27	Stacked Die Package for MEMS Resonator System
8,667,665	13/562,684	31-Jul-12	11/963,709	21-Dec-07	28	13-Jan-28	Method of Manufacturing a Microelectromechanical System (MEMS) Resonator
8,324,729	13/151/316	2-Jun-11	60/813,874	15-Jun-07	0	10-Jun-27	Stacked die package for MEMS resonator system
8,299,826	12/860,875	21-Aug-10	61/236,682	21-Aug-10	150	13-Jun-31	Phase Locked Loop Circuitry Having Switched Resistor Loop Filter Circuitry, and Methods of Operating Same
8,283,987	12/897,361	4-Oct-10	60/970,233	24-Mar-08	0	19-Mar-28	Resonator Electrode Shields
8,234,774	11/963,709	21-Dec-07	11/963,709	21-Dec-07	616	23-Aug-29	Method for Fabricating a Microelectromechanical System (MEMS) Resonator
8,022,554	11/763,801	15-Jun-07	60/813,874	15-Jun-07	247	12-Feb-28	Stacked die package for MEMS resonator system
7,808,332	12/054,300	24-Mar-08	60/970,233	24-Mar-08	283	27-Dec-28	Resonator electrode shields
7,545,239	11/613,910	20-Dec-06	11/613,910	20-Dec-06	98	23-Mar-27	Serrated MEMS resonators
7,545,238	11/613,886	20-Dec-06	11/613,886	20-Dec-06	100	25-Mar-27	Serrated MEMS resonators
7,545,237	11/613,869	20-Dec-06	11/613,869	20-Dec-06	86	11-Mar-27	Serrated MEMS resonators
7,545,228	11/854,517	12-Sep-07	11/854,517	12-Sep-07	107	23-Dec-27	Dynamic temperature compensation for a digitally controlled oscillator using dual MEMS resonators
7,544,531	11/770,509	28-Jun-07	60/894,604	28-Jun-07	193	2-Jan-28	Ground strap for suppressing stiction during MEMS fabrication
7,446,620	11/493,226	26-Jun-06	11/453,314	14-Jun-06	100	17-Sep-26	Microelectromechanical oscillator having temperature measurement system, and method of operating same
7,446,619	11/453,314	26-Jun-06	11/453,314	14-Jun-06	2	11-Jun-26	Temperature measurement system having a plurality of microelectromechanical resonators and method of operating same
7,443,258	11/339,176	6-Apr-06	11/339,176	6-Apr-06	0	1-Apr-26	Oscillator system having a plurality of microelectromechanical resonators and method of designing, controlling or operating same
7,403,147	11/606,681	29-Nov-06	11/606,681	29-Nov-06	0	24-Nov-26	Precision capacitor array
7,369,004	11/493,704	26-Jul-06	11/453,314	14-Jun-06	0	9-Jun-26	Microelectromechanical oscillator and method of operating same
7,369,003	11/438,653	22-May-06	11/399,176	6-Apr-06	0	1-Apr-26	Oscillator system having a plurality of microelectromechanical resonators and method of designing, controlling or operating the same

SiTime Docket

Application	Matter	Filed Date	Priority From	Type	Status	Title
	SITC.103-Prov		Self	Provisional	File in 2014	Contoured Rings for Micromechanical Resonators
	SITC.102-Prov		Self	Provisional	Hold for lab data 2014	Trimming MEMS Resonator Parameters
14/300,114	SIT1/0017-D3	9-Jun-14	Provisional 60/970,233 and US 7,808,332	Divisional	Filed 06/09/14	Resonator Electrode Shields
14/191,978	SIT1/0026-D3	27-Feb-14	Provisional 60/813,874 and US 8022554	Divisional	Filed	Stacked Die Package for MEMS Resonator System
14/191,939	SIT1/029-D2	27-Feb-14	US 8,234,774	Divisional	Filed	Temperature Stable MEMS Resonator
61/937,601	SITC.101-Prov	9-Feb-14	Self	Provisional	Filed	MEMS Resonator with Improved Control of Temperature Coefficients of Frequency
13/837,407	307.005-US	15-Mar-13	Provisional Mar-'12	Converted	Pending	MEMS Device and Method of Manufacturing Same
13/759,013	307.004-US	4-Feb-13	Provisional Feb-'12	Converted	ROA 5/27/14	Temperature Insensitive Resonant Elements and Oscillators and Methods of Designing and Manufacturing Same
13/653,640	307.001-D1	17-Oct-12	8,229,826	Divisional	Allowed 05/01/14	Phase Locked Loop Circuitry Having Switched Resistor Loop Filter Circuitry, and Methods of Operating Same
13/607,603	307.003-US	7-Sep-12	61/533,149	Converted	Pending	Circuitry and Techniques for Resistor-Based Temperature Sensing
13/607,597	307.002-US	7-Sep-12	61/533,148	Converted	Received OA 06/16/14	Micromachined Thermistor and Temperature Measurement Circuitry, and Method of Manufacturing and Operating Same
11/593,404	SIT1/0023-D7 (209.001)	6-Nov-06	11/336,521 (20- Jan 06)	Ordinary	ROA 5/27/14	Wafer Encapsulated Microelectromechanical Structure and Method of Manufacturing Same

*Expiration dates are nominal, variations from these dates are possible.